

## 4V Drive Pch MOSFET RSJ250P10FRA

## \_\_\_\_\_

## Structure

Silicon P-channel MOSFET

#### Features

1) Low on-resistance.

2) Built-in G-S Protection Diode.

## Application

Switching

#### Packaging specifications

	Package	Taping
Туре	Code	TL
	Basic ordering unit (pieces)	1000
RSJ250P1	0	

#### • Absolute maximum ratings (Ta = 25°C)

Paran	Symbol	Limits	Unit	
Drain-source voltage	V <sub>DSS</sub>	-100	V	
Gate-source voltage		V <sub>GSS</sub>	±20	V
Drain current	Continuous	I <sub>D</sub> *1	±25	А
Drain current	Pulsed	<sub>DP</sub> *2	±50	А
Source current	Continuous	l <sub>s</sub> *1	-25	А
(Body Diode)	Pulsed	l <sub>SP</sub> *2	-50	А
Power dissipation	P <sub>D</sub> *3	50	W	
Channel temperature	Tch	150	°C	
Range of storage temperature		Tstg	-55 to +150	°C

\*1 Limited only by maximum temperature allowed.

\*2 P<sub>W</sub>≤10μs, Duty cycle≤1%

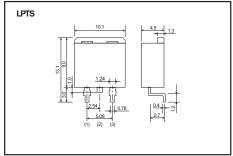
\*3 T<sub>C</sub>=25°C

#### • Thermal resistance

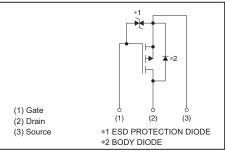
Parameter	Symbol	Limits	Unit
Channel to Ambient	Rth (ch-c)*	2.5	°C/W

\* T<sub>C</sub>=25°C

## • Dimensions (Unit : mm)



#### Inner circuit



## Data Sheet

## • Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I <sub>GSS</sub>	-	-	±10	μA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	-100	-	-	V	I <sub>D</sub> =–1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	I <sub>DSS</sub>	-	-	-1	μA	V <sub>DS</sub> =-100V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	-1.0	-	-2.5	V	$V_{DS}$ =-10V, $I_{D}$ =-1mA
Otatia duain accuracy an atata		-	45	63		I <sub>D</sub> =–25A, V <sub>GS</sub> =–10V
Static drain-source on-state resistance	R <sub>DS (on)</sub>	-	48	67	mΩ	I <sub>D</sub> =-12.5A, V <sub>GS</sub> =-4.5
		-	50	70	I	I <sub>D</sub> =-12.5A, V <sub>GS</sub> =-4.0V
Forward transfer admittance	۱ Y <sub>fs</sub> ľ	20	-	-	S	I <sub>D</sub> =–25A, V <sub>DS</sub> =–10V
Input capacitance	C <sub>iss</sub>	-	8000	-	pF	V <sub>DS</sub> =-25V
Output capacitance	C <sub>oss</sub>	-	300	-	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	C <sub>rss</sub>	-	200	-	pF	f=1MHz
Turn-on delay time	t <sub>d(on)</sub> *	-	30	-	ns	I <sub>D</sub> =–12.5A, V <sub>DD</sub> ≒–50\
Rise time	t <sub>r</sub> *	-	67	-	ns	V <sub>GS</sub> =-10V
Turn-off delay time	t <sub>d(off)</sub> *	-	310	-	ns	$R_L=4\Omega$
Fall time	t <sub>f</sub> *	-	180	-	ns	R <sub>G</sub> =10Ω
Total gate charge	Q <sub>g</sub> *	-	60	-	nC	I <sub>D</sub> =–25A
Gate-source charge	Q <sub>gs</sub> *	-	17	-	nC	V <sub>DD</sub> ≒-50V
Gate-drain charge	Q <sub>gd</sub> *	-	19	-	nC	V <sub>GS</sub> =-5V

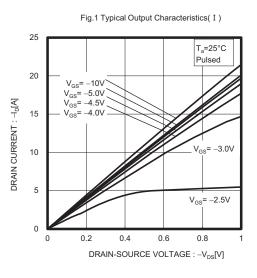
\*Pulsed

## •Body diode characteristics (Source-Drain) (Ta = 25°C)

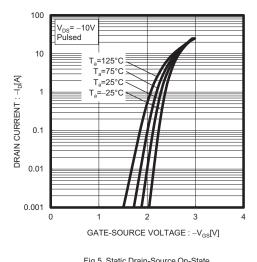
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Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward Voltage	$V_{SD}^{*}$	-	-	-1.2	V	I <sub>s</sub> =–25A, V <sub>GS</sub> =0V

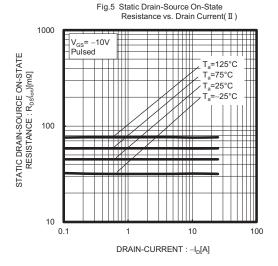
\*Pulsed

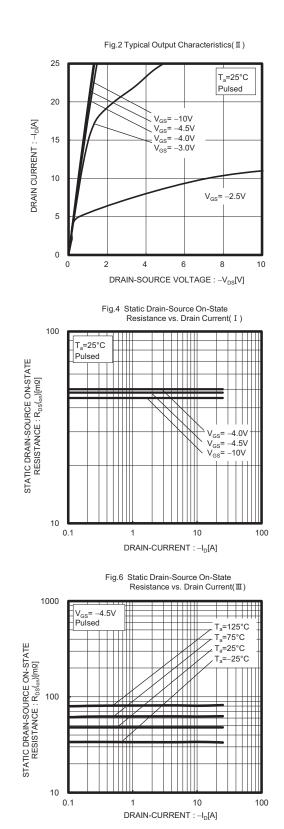
#### •Electrical characteristic curves (Ta=25°C)

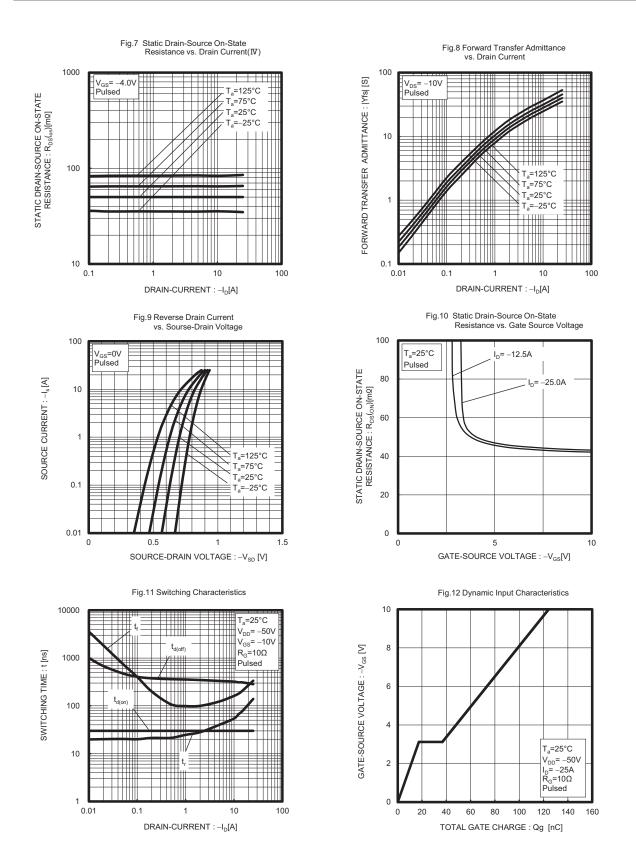












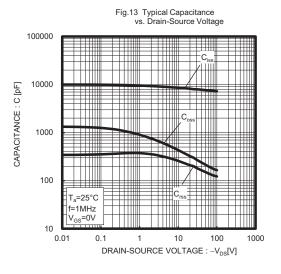


Fig.15 Normalized Transient Thermal Resistance vs. Pulse Width

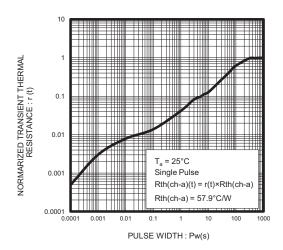
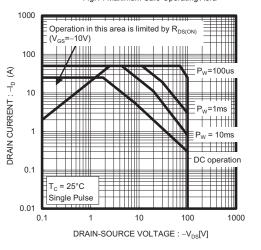


Fig.14 Maximum Safe Operating Aera



#### Measurement circuits

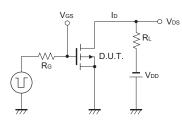
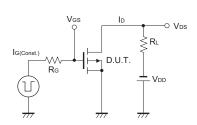
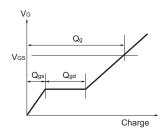


Fig.1-1 Switching Time Measurement Circuit





Pulse Width

10%

90%

tr

90%

td(

Fig.1-2 Switching Waveforms

50%

10%

90%

tr

10% - 50%

Vas

VDS \_\_\_\_\_

Fig.2-1 Gate Charge Measurement Circuit

Fig.2-2 Gate Charge Waveform

# Notice

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1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

JAPAN	USA	EU	CHINA	
CLASSI	CLASSⅢ	CLASS II b	CLASSII	
CLASSⅣ	CLASSI	CLASSⅢ	CLASSII	

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  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

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# RSJ250P10FRA - Web Page

Part Number	RSJ250P10FRA
Package	LPTS(D2PAK)
Unit Quantity	1000
Minimum Package Quantity	1000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes